

COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	BVDSS	Rds(on) max	I _D Ta = +25°C
N Observal	001/	35mΩ @ V _{GS} = 4.5V	4.5A
N-Channel	20V	56mΩ @ V _{GS} = 1.8V	3.5A
P-Channel -20V		74mΩ @ V _{GS} = -4.5V	-3.1A
		168mΩ @ V _{GS} = -1.8V	-2.0A

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is gualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Motor controls
- **DC-DC** converters
- Power management functions

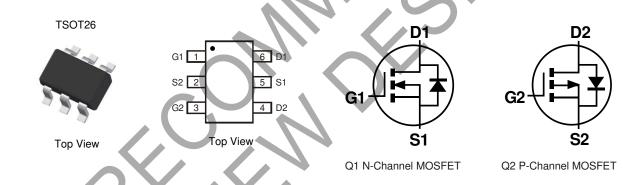
Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMC2038LVTQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/guality/product-definitions/

Mechanical Data

- Package: TSOT26
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (c3)
- Weight: 0.013 grams (Approximate)



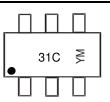
Ordering Information (Note 4)

Part Number		Package	Packing		
	Fait Number	Fackaye	Qty.	Carrier	
	DMC2038LVTQ-7	TSOT26	3000	Tape & Reel	
Notes:	1. No purposely added lead. Fully I	EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS)	2) & 2015/863/EU (RoHS 3) comp	liant.	

02/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant 2. See https://www.diodes.com/guality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</p>
4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



31C = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: J = 2022)

M or \overline{M} = Month (ex: 9 = September)

Date Code Key Year 2019 2022 2023 2024 2025 2026 2027 2028 2029 2030 2031 Code G K Μ Ν 0 Ρ R S Sep Oct Nov Dec Month Feb Mar May Jun Jul Aug Jan Apr 8 9 0 Ν D Code 3 5 2 4 6

DMC2038LVTQ Document number: DS42188 Rev. 3 - 3

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Maximum Ratings N-CHANNEL - Q1 (@TA = +25°C, unless otherwise specified.)

Characteristic			Value	Unit	
Drain-Source Voltage				V	
		Vgss	±12	V	
Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	lD	3.7 3.0	А	
t<10s	T _A = +25°C T _A = +70°C	ID	4.1 3.2	А	
Steady State	$T_{A} = +25^{\circ}C$ $T_{A} = +70^{\circ}C$	ID	4.5 3.6	А	
t<10s	TA = +25°C TA = +70°C	ID	5.2 4.2	А	
Maximum Continuous Body Diode Forward Current (Note 7)			1.5	А	
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%)			25	А	
	State t<10s Steady State t<10s nt (Note 7)	$\begin{tabular}{ c c c c } \hline State & T_A = +70^\circ C \\ \hline t < 10s & T_A = +25^\circ C \\ \hline T_A = +70^\circ C \\ \hline Steady & T_A = +25^\circ C \\ \hline State & T_A = +70^\circ C \\ \hline t < 10s & T_A = +25^\circ C \\ \hline T_A = +70^\circ C \\ \hline nt (Note 7) \\ \hline \end{tabular}$	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	$\begin{tabular}{ c c c c c c c c c c c } \hline V_{DSS} & 20 \\ \hline V_{GSS} & \pm 12 \\ \hline Steady & T_A = +25^{\circ}C & & & & & & & & & & & & & & & & & & &$	

Maximum Ratings P-CHANNEL - Q2 (@TA = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			VDSS	-20	V
Gate-Source Voltage			VGSS	±12	V
		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	lo	-2.6 -2.1	A
Continuous Drain Current (Note 5) V _{GS} = -4.5V	t<10s	T _A = +25°C T _A = +70°C	lD	-2.9 -2.4	A
	Steady State	TA = +25°C TA = +70°C	ID	-3.1 -2.5	A
Continuous Drain Current (Note 6) V _{GS} = -4.5V	t<10s	TA = +25°C TA = +70°C	lo	-3.8 -3.0	A
Maximum Continuous Body Diode Forward Current (Note 7)			ls	-1.5	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			Ідм	-17	A

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	TA = +25°C	Pp	0.8	w
Total Power Dissipation (Note 3)	$T_A = +70^{\circ}C$	PD	0.5	vv
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	168	°C/W
mermai Resistance, sunction to Ambient (Note 5)	t<10s	Reja	120	C/W
Total Power Dissipation (Note 6)	TA = +25°C	PD	1.1	w
Total Power Dissipation (Note 0)	$T_A = +70^{\circ}C$	FD	0.7	vv
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Dave	114	
mermar Resistance, sunction to Ambient (Note 6)	t<10s	Reja	72	°C/W
Thermal Resistance, Junction to Case (Note 6)		R _{eJC}	39	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect. Notes:



Electrical Characteristics Q1 N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	20	_	—	V	$V_{GS} = 0V, I_{D} = 250 \mu A$
Zero Gate Voltage Drain Current @T _C = +25°C	IDSS	—	_	1.0	μA	$V_{DS} = 16V, V_{GS} = 0V$
Gate-Source Leakage	lgss	—		±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						-
Gate Threshold Voltage	V _{GS(TH)}	0.4		1.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
		—	27	35		$V_{GS} = 4.5V, I_D = 4.0A$
Static Drain-Source On-Resistance	RDS(ON)	—	33	43	mΩ	VGS = 2.5V, ID = 2.5A
		—	43	56		Vgs = 1.8V, Id = 1.5A
Forward Transfer Admittance	Y _{fs}	—	9		S	Vds = 5V, Id = 3.4A
Diode Forward Voltage	VSD	0.4	_	1.1	V	Vgs = 0V, Is = 1A
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	—	400	530	pF	
Output Capacitance	Coss	_	70	90	pF	Vps = 10V, Vgs = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss	—	65	100	pF	
Gate Resistance	Rg	—	1.9		Ω	VDS = 0V, VGS = 0V, f = 1MHz
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	5.7		nC	
Total Gate Charge (V _{GS} = 10V)	Q _g		12	17	nC	
Gate-Source Charge	Q _{gs}	-	0.7		nC	→VDS = 15V, ID = 5.8A
Gate-Drain Charge	Q _{gd}		1.4		nC	
Turn-On Delay Time	tD(ON)	-	5	10	ns	
Turn-On Rise Time	tR	—	8	16	ns	V _{DS} = 10V, V _{GS} = 4.5V,
Turn-Off Delay Time	tD(OFF)	_	25	40	ns	Rg = 6Ω, I _{DS} = 1A
Turn-Off Fall Time	tF	+	8	16	ns	7

Notes:7. Short duration pulse test used to minimize self-heating effect.8. Guaranteed by design. Not subject to production testing.





Electrical Characteristics Q2 P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

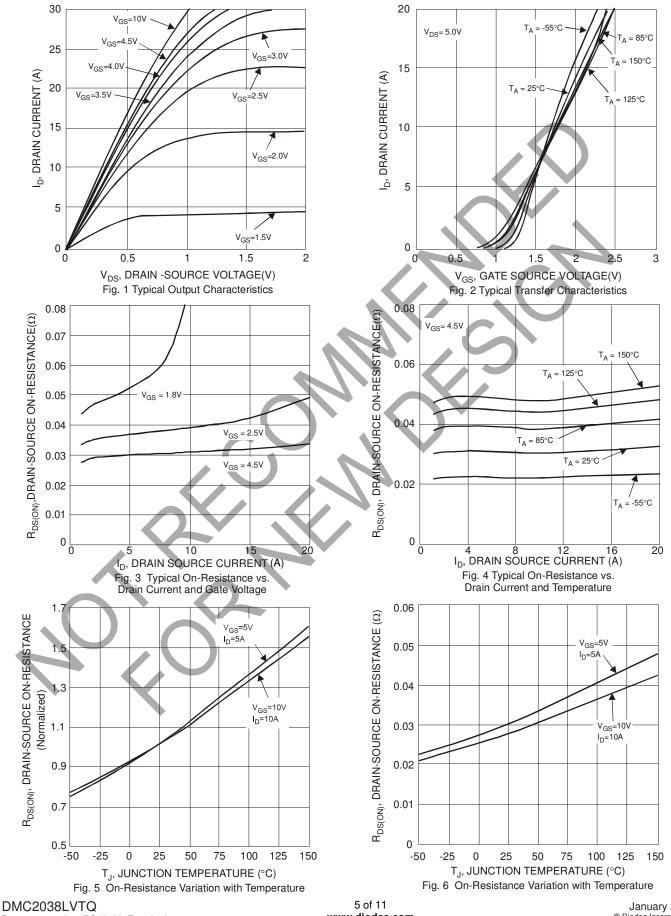
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	-20	—	_	V	Vgs = 0V, Id = -250µA
Zero Gate Voltage Drain Current @Tc = +25°C	IDSS		—	-1.0	μA	$V_{DS} = -16V, V_{GS} = 0V$
Gate-Source Leakage	Igss	—	—	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	-0.4	—	-1.0	V	$V_{DS} = V_{GS}, I_D = -250 \mu A$
			57	74		$V_{GS} = -4.5V, I_D = -3.0A$
Static Drain-Source On-Resistance	RDS(ON)		76	110	mΩ	VGs = -2.5V, I _D = -1.5A
		_	102	168		Vgs = -1.8V, Id = -1.0A
Forward Transfer Admittance	Y _{fs}	_	10	_	S	VDS = -5V, ID = -3.0A
Diode Forward Voltage	Vsd	_	-0.8	-1.0	V	Vgs = 0V, Is = -0.6A
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	_	530	705	pF	
Output Capacitance	Coss	_	70	95	pF	V _{DS} = -10V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss		60	90	pF	
Gate Resistance	Rg		72		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	7	10	nC	
Total Gate Charge (V _{GS} = -10V)	Qg 📢		14		nC	
Gate-Source Charge	Q _{gs}	—	0.95		nC	→VDS = -15V, ID = -6A
Gate-Drain Charge	Q _{gd}		1.2		nC	7
Turn-On Delay Time	td(on)	+	11	20	ns	
Turn-On Rise Time	tR	—	12	22	ns	V _{DS} = -10V, V _{GS} = -4.5V,
Turn-Off Delay Time	tD(OFF)	_	21	34	ns	Rg = 6Ω, Is = -1A
Turn-Off Fall Time	tF	+	13	23	ns	

Notes: 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to production testing.





Typical Characteristics - N-CHANNEL

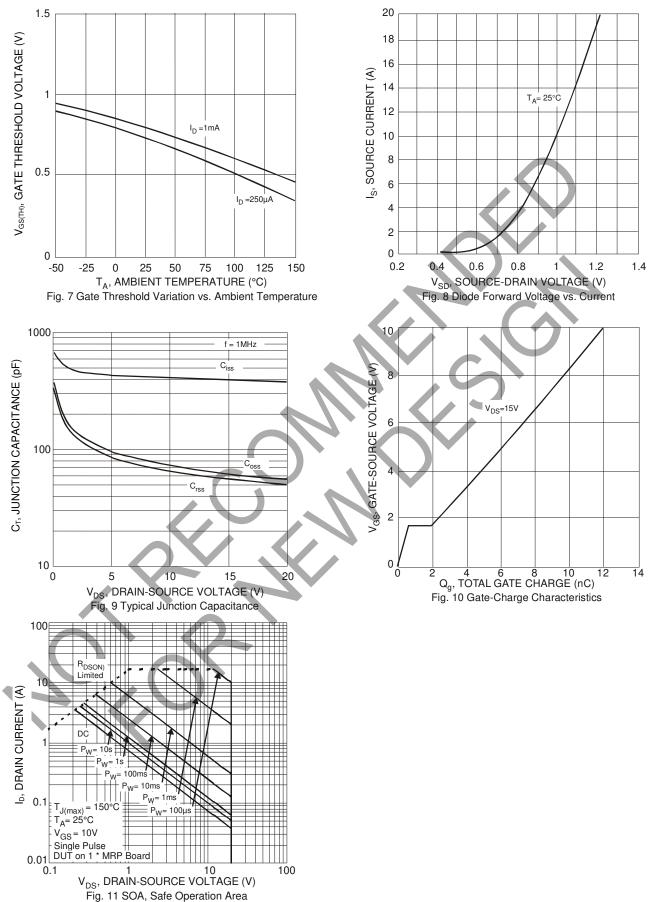


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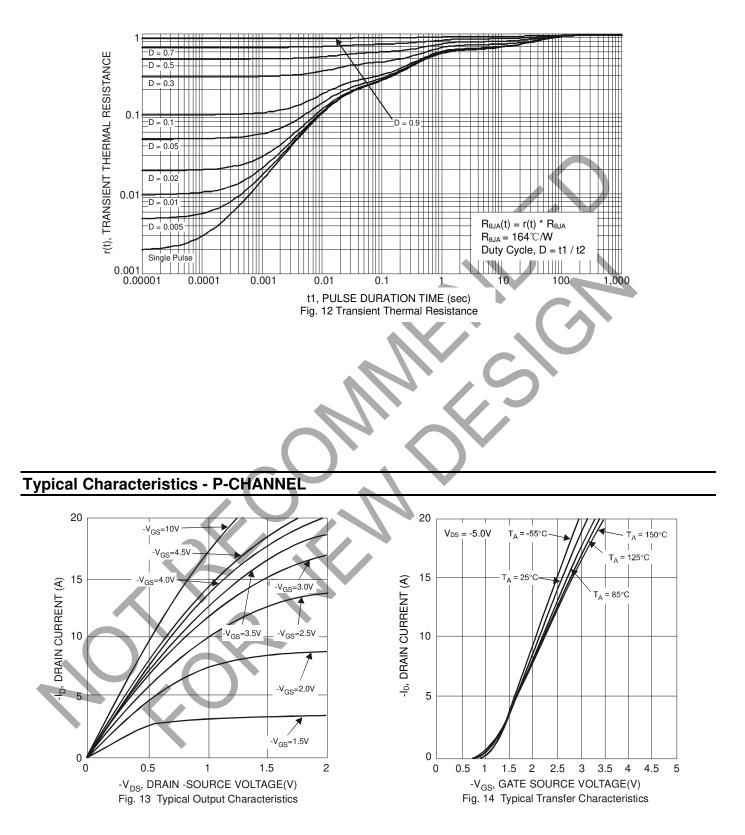
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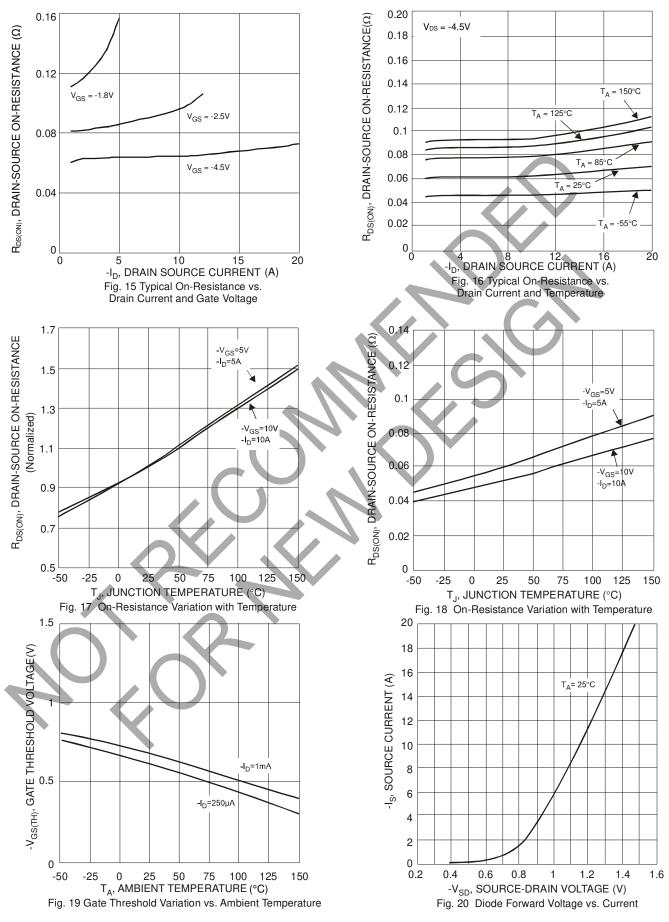






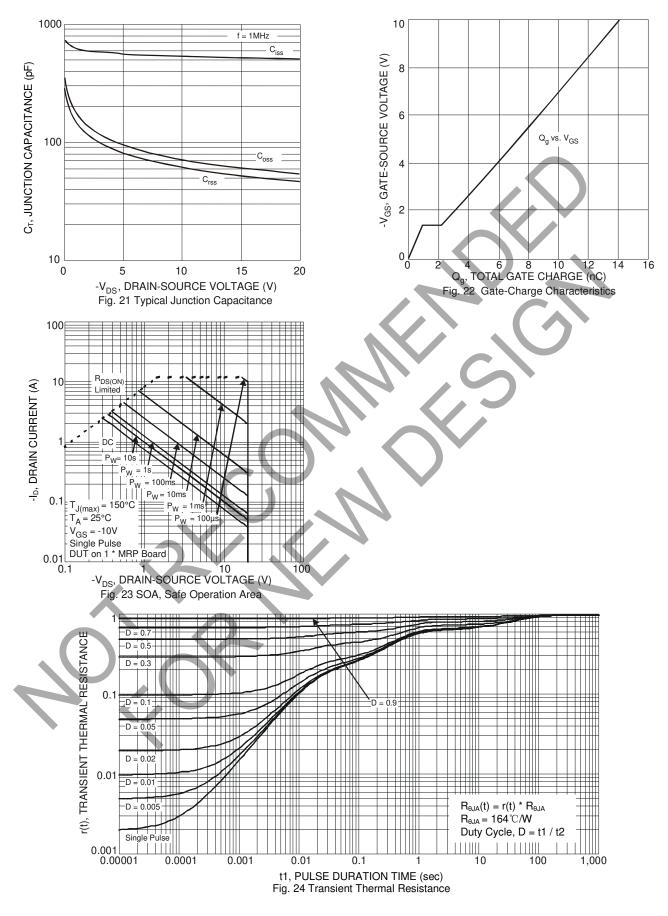


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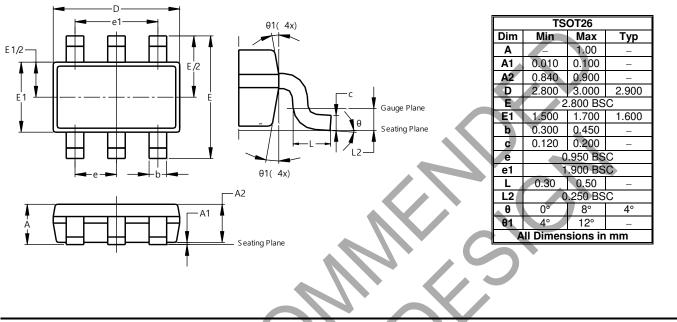




Package Outline Dimensions

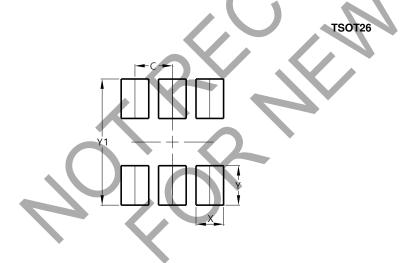
Please see http://www.diodes.com/package-outlines.html for the latest version.

TSOT26



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.200



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